

ANNEX

In Annex IV to Directive 2011/65/EU, point 26 is replaced by the following:

26. Lead in the following applications that are used durably at a temperature below – 20 °C under normal operating and storage conditions:

- (a) solders on printed circuit boards;
- (b) termination coatings of electrical and electronic components and coatings of printed circuit boards;
- (c) solders for connecting wires and cables;
- (d) solders connecting transducers and sensors.

Lead in solders of electrical connections to temperature measurement sensors in devices which are designed to be used periodically at temperatures below – 150 °C.

These exemptions expire on 30 June 2021.